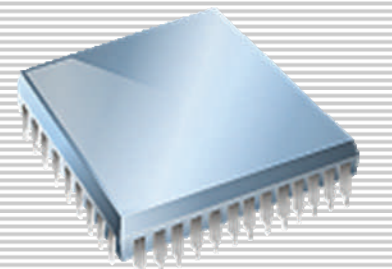


Company Background

TECH Semiconductor Singapore is a leading, joint-venture 300mm wafer fabrication plant. It was set up in 1991 to specialize in manufacturing Dynamic Random Access Memory (DRAM). TECH's DRAM process uses advanced cutting-edge technology-deep UV steppers, scanners, advanced dry etch processes, CMP (Chemical Mechanical Polishing), new advanced techniques of metallization and sub-quarter micron technology. Their final DRAM products are used as memories in Computers, Servers & Workstations, Communications Electronics Military, Aerospace Electronics, Automotive Electronics, Office Automation Equipment and Video Games.

Problem Definition

- To schedule preventive maintenance (PM) for TECH's 100+ machines in the production line
- To automate the PM scheduling process
- To optimize PM scheduling in order to maximize system throughput and minimize inventory cost



Methodology & Approach

- Mixed Integer Programming (Optimization)

Objective:

$$\max \sum_{t=1}^T \left(\sum_{e=1}^E (b_e \cdot \min[K_e V_e'(t), I_e(t)] - c_e^I \cdot I_e(t)) - \sum_{l=1}^M \sum_{i=1}^{\rho_l} c_l^P \cdot a_l^i(t) \right)$$

Subject to:

$$\sum_{t=w_l^i}^{u_l^i} a_l^i(t) = 1, \text{ for those PM tasks that have to be finished in the time window } [w_l^i, u_l^i] \subseteq [1, T]$$

$$V_i(t) = f_i(a_i(t), a_i(t-1), \dots, a_i(t-(k_i-1))) \text{ for } t = 1, \dots, M; t = 1, \dots, T; a_i(t) = 0, \text{ for } t \leq 0$$

$$\sum_{i=1}^M V_e'(t) = V_i(t), \text{ for } t = 1, \dots, M$$

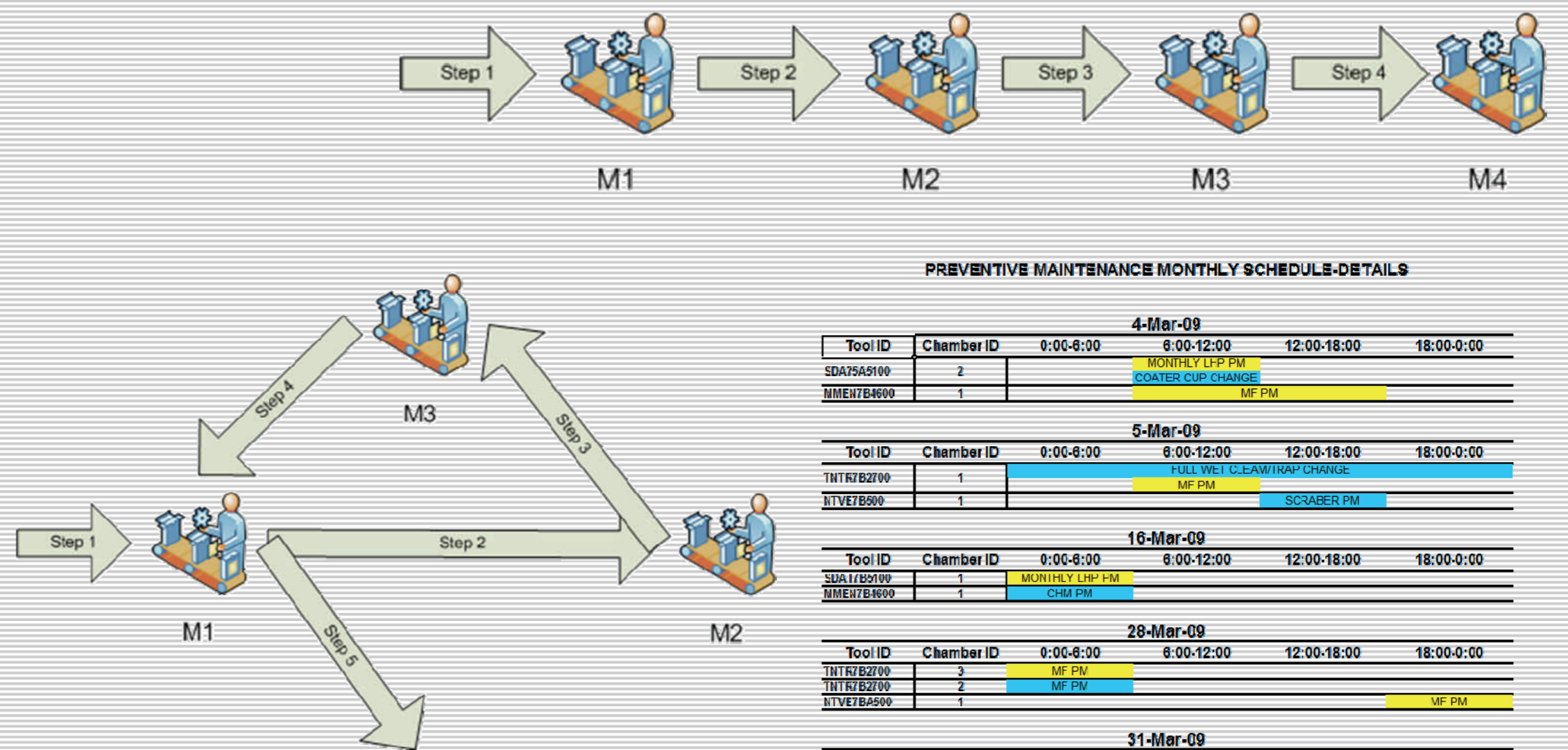
$$R^j(t) \geq \sum_{i=1}^M r_i^j(a_i(t), a_i(t-1), \dots, a_i(t-(k_i-1))), \text{ for } t = 1, \dots, T; j = 1, \dots, N; a_i(t) = 0, \text{ for } t \leq 0, d_0(t) = D(t)$$

$$I_e(t+1) = (I_e(t) - K_e \cdot V_e'(t) + d_e(t))^+ \text{ for } e = 1, \dots, E; t = 1, \dots, T-1, d_{e+1}(t) = \min[K_e V_e'(t), I_e(t)], \text{ for } t = 1, \dots, T; e = 1, \dots, E-1$$

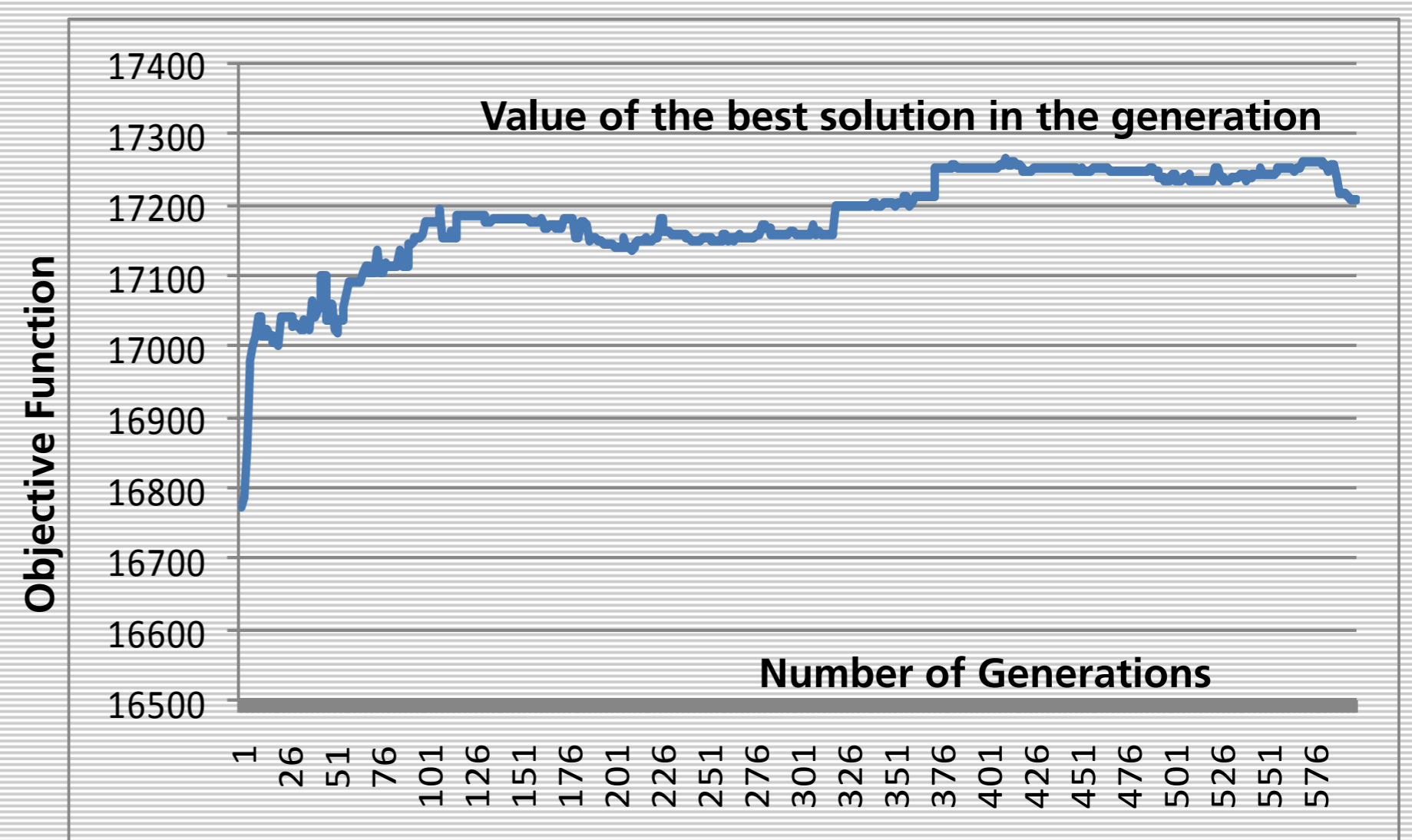
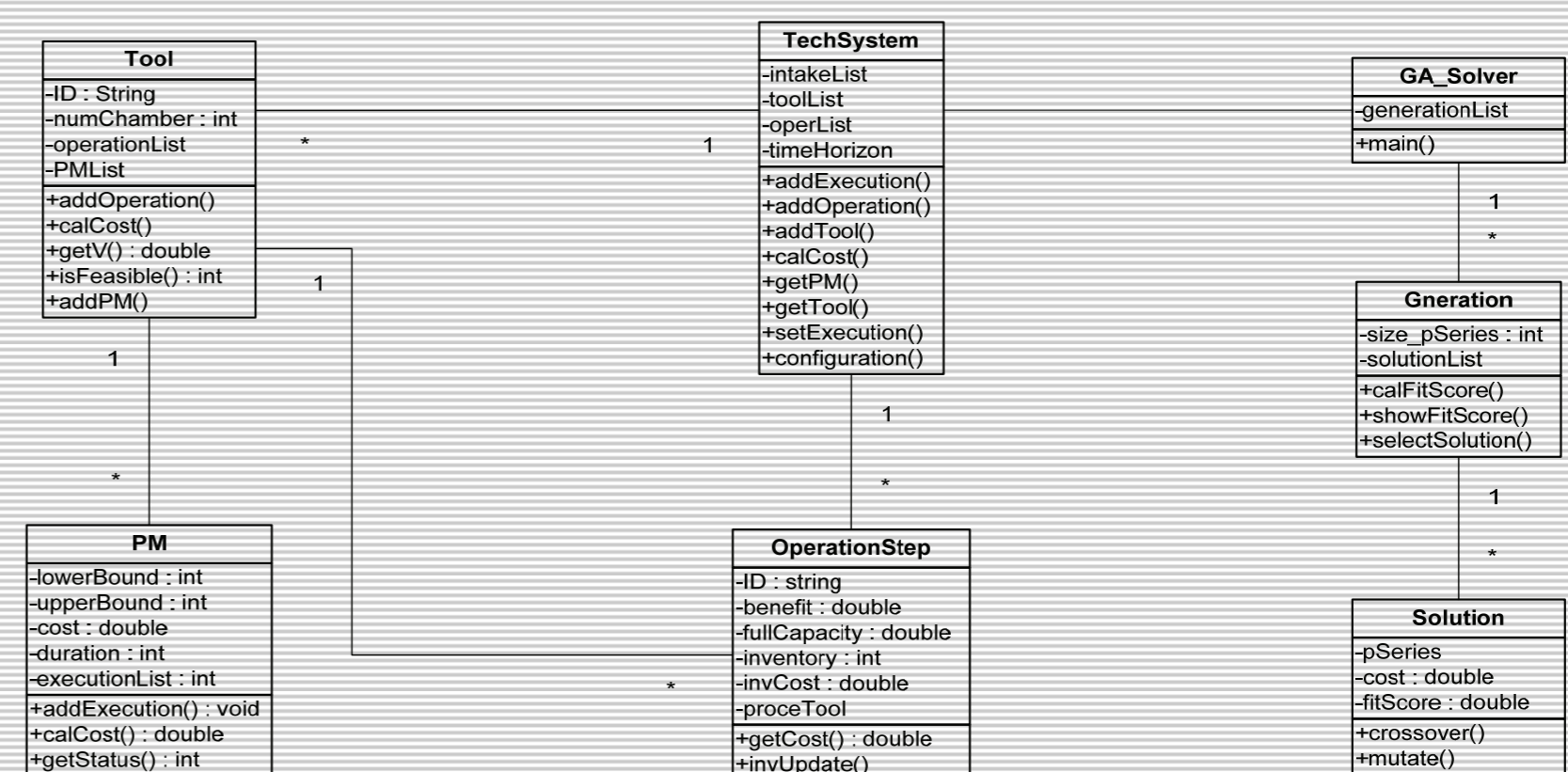
$$I_e(t) \leq L_e, \text{ for } e = 1, \dots, E; t = 1, \dots, T.$$

Parameters

- M : Number of tools considered.
- T : Number of time units in the planning horizon.
- N : Number of source types considered.
- E : Number of steps considered.
- i_e^l : The tool processes step.
- ρ_l : Number of PM tasks on tool l .
- w_l^i, u_l^i : Time window [min, max] associated with PM task l on tool i .
- k_i : Number of periods for the PM task with the longest duration on tool i .
- b_e : Profit coefficient for processing one wafer on tool i_e^l in step e .
- c_e^I : Cost coefficient for inventory on step e .
- c_l^P : PM cost for performing PM task l on tool i .
- L_e : WIP buffer size for step e .
- K_e : Coefficient of wafer throughput for tool i_e^l 's availability for step e .
- $f_i(\cdot)$: Availability function for tool i ; constructed from the "configuration matrix"
- $r_i^j(\cdot)$: Resource function calculating the requirement of resource type j for tool i ; $j = 1, \dots, N$; constructed from a resource requirement matrix.
- $R^j(t)$: Amount of resource type j available in period t , $j = 1, \dots, N$.
- $D(t)$: Amount of wafer coming (WIP) to step one.



- Genetic Algorithm (Heuristics with JAVA programming)



(the graph is resulted from testing data)

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